

EasyPACK™ module with TRENCHSTOP™ IGBT7 and CoolSiC™ Schottky diode and PressFIT / NTC

Features

- Electrical features
 - $V_{CES} = 950\text{ V}$
 - $I_{C\text{nom}} = 100\text{ A} / I_{CRM} = 200\text{ A}$
 - CoolSiC™ Schottky diode gen 5
 - Low switching losses
 - TRENCHSTOP™ IGBT7
- Mechanical features
 - Al_2O_3 substrate with low thermal resistance
 - Compact design
 - Integrated NTC temperature sensor
 - PressFIT contact technology



Potential applications

- UPS systems
- Three-level applications
- Solar applications

Product validation

- Qualified for industrial applications according to the relevant tests of IEC 60747, 60749 and 60068

Description

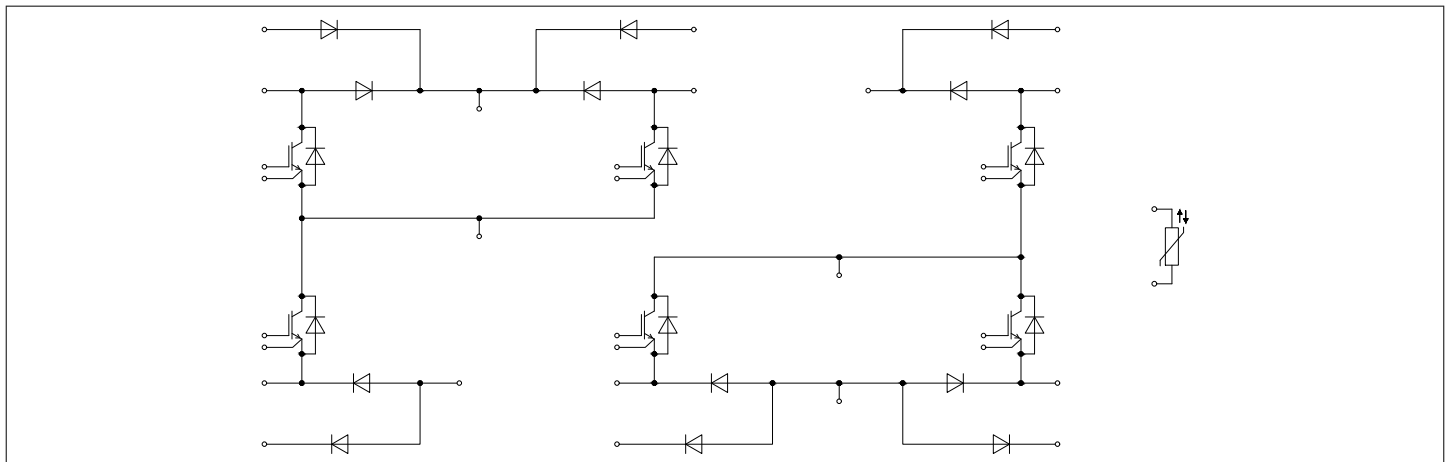


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1 Package

Table 1 Insulation coordination

| Parameter | Symbol | Note or test condition | Values | Unit |
|-------------------------------------|-------------|--|-----------|------|
| Isolation test voltage | V_{ISOL} | RMS, $f = 50 \text{ Hz}$, $t = 1 \text{ min}$ | 3.2 | kV |
| Internal isolation | | basic insulation (class 1, IEC 61140) | Al_2O_3 | |
| Creepage distance | d_{Creep} | terminal to heatsink | 11.2 | mm |
| Creepage distance | d_{Creep} | terminal to terminal | 6.8 | mm |
| Clearance | d_{Clear} | terminal to heatsink | 9.4 | mm |
| Clearance | d_{Clear} | terminal to terminal | 5.5 | mm |
| Comparative tracking index | CTI | | >400 | |
| Relative thermal index (electrical) | RTI | housing | 140 | °C |

Table 2 Characteristic values

| Parameter | Symbol | Note or test condition | Values | | | Unit |
|-------------------------------------|-----------|--|-----------|------|------|------|
| | | | Min. | Typ. | Max. | |
| Stray inductance module | L_{SCE} | | | 22 | | nH |
| Storage temperature | T_{stg} | | -40 | | 125 | °C |
| Mounting torque for module mounting | M | - Mounting according to valid application note | M5, Screw | 1.3 | 1.5 | Nm |
| Weight | G | | | 78 | | g |

Note: The current under continuous operation is limited to 25A rms per connector pin.

2 IGBT, Boost

Table 3 Maximum rated values

| Parameter | Symbol | Note or test condition | Values | Unit |
|-----------------------------------|-----------|--|--------|------|
| Collector-emitter voltage | V_{CES} | $T_{vj} = 25 \text{ °C}$ | 950 | V |
| Implemented collector current | I_{CN} | | 100 | A |
| Continuous DC collector current | I_{CDC} | $T_{vj \text{ max}} = 175 \text{ °C}$ $T_H = 65 \text{ °C}$ | 70 | A |
| Repetitive peak collector current | I_{CRM} | t_p limited by $T_{vj \text{ op}}$ | 200 | A |
| Gate-emitter peak voltage | V_{GES} | | ±20 | V |

Table 4 Characteristic values

| Parameter | Symbol | Note or test condition | Values | | | Unit | |
|---|---------------|--|--------------------------|------|-------|-------|----------|
| | | | Min. | Typ. | Max. | | |
| Collector-emitter saturation voltage | $V_{CE\ sat}$ | $I_C = 30\ A, V_{GE} = 15\ V$ | $T_{vj} = 25\ ^\circ C$ | | 1.33 | 1.53 | V |
| | | | $T_{vj} = 125\ ^\circ C$ | | 1.39 | | |
| | | | $T_{vj} = 150\ ^\circ C$ | | 1.40 | | |
| Gate threshold voltage | V_{GETh} | $I_C = 1.67\ mA, V_{CE} = V_{GE}, T_{vj} = 25\ ^\circ C$ | | 4.35 | 5.10 | 5.85 | V |
| Gate charge | Q_G | $V_{GE} = \pm 15\ V, V_{CE} = 600\ V$ | | | 0.23 | | μC |
| Internal gate resistor | R_{Gint} | $T_{vj} = 25\ ^\circ C$ | | | 1.5 | | Ω |
| Input capacitance | C_{ies} | $f = 100\ kHz, T_{vj} = 25\ ^\circ C, V_{CE} = 25\ V, V_{GE} = 0\ V$ | | | 6.48 | | nF |
| Reverse transfer capacitance | C_{res} | $f = 100\ kHz, T_{vj} = 25\ ^\circ C, V_{CE} = 25\ V, V_{GE} = 0\ V$ | | | 0.02 | | nF |
| Collector-emitter cut-off current | I_{CES} | $V_{CE} = 950\ V, V_{GE} = 0\ V$ | $T_{vj} = 25\ ^\circ C$ | | | 0.031 | mA |
| Gate-emitter leakage current | I_{GES} | $V_{CE} = 0\ V, V_{GE} = 20\ V, T_{vj} = 25\ ^\circ C$ | | | | 100 | nA |
| Turn-on delay time (inductive load) | t_{don} | $I_C = 30\ A, V_{CE} = 500\ V, V_{GE} = \pm 15\ V, R_{Gon} = 10\ \Omega$ | $T_{vj} = 25\ ^\circ C$ | | 0.060 | | μs |
| | | | $T_{vj} = 125\ ^\circ C$ | | 0.060 | | |
| | | | $T_{vj} = 150\ ^\circ C$ | | 0.060 | | |
| Rise time (inductive load) | t_r | $I_C = 30\ A, V_{CE} = 500\ V, V_{GE} = \pm 15\ V, R_{Gon} = 10\ \Omega$ | $T_{vj} = 25\ ^\circ C$ | | 0.020 | | μs |
| | | | $T_{vj} = 125\ ^\circ C$ | | 0.020 | | |
| | | | $T_{vj} = 150\ ^\circ C$ | | 0.020 | | |
| Turn-off delay time (inductive load) | t_{doff} | $I_C = 30\ A, V_{CE} = 500\ V, V_{GE} = \pm 15\ V, R_{Goff} = 10\ \Omega$ | $T_{vj} = 25\ ^\circ C$ | | 0.180 | | μs |
| | | | $T_{vj} = 125\ ^\circ C$ | | 0.220 | | |
| | | | $T_{vj} = 150\ ^\circ C$ | | 0.240 | | |
| Fall time (inductive load) | t_f | $I_C = 30\ A, V_{CE} = 500\ V, V_{GE} = \pm 15\ V, R_{Goff} = 10\ \Omega$ | $T_{vj} = 25\ ^\circ C$ | | 0.080 | | μs |
| | | | $T_{vj} = 125\ ^\circ C$ | | 0.120 | | |
| | | | $T_{vj} = 150\ ^\circ C$ | | 0.130 | | |
| Turn-on energy loss per pulse | E_{on} | $I_C = 30\ A, V_{CE} = 500\ V, L_\sigma = 35\ nH, V_{GE} = \pm 15\ V, R_{Gon} = 10\ \Omega, di/dt = 1900\ A/\mu s (T_{vj} = 150\ ^\circ C)$ | $T_{vj} = 25\ ^\circ C$ | | 0.525 | | mJ |
| | | | $T_{vj} = 125\ ^\circ C$ | | 0.557 | | |
| | | | $T_{vj} = 150\ ^\circ C$ | | 0.567 | | |
| Turn-off energy loss per pulse | E_{off} | $I_C = 30\ A, V_{CE} = 500\ V, L_\sigma = 35\ nH, V_{GE} = \pm 15\ V, R_{Goff} = 10\ \Omega, dv/dt = 3500\ V/\mu s (T_{vj} = 150\ ^\circ C)$ | $T_{vj} = 25\ ^\circ C$ | | 0.72 | | mJ |
| | | | $T_{vj} = 125\ ^\circ C$ | | 1.21 | | |
| | | | $T_{vj} = 150\ ^\circ C$ | | 1.37 | | |
| Thermal resistance, junction to heat sink | R_{thJH} | per IGBT, $\lambda_{grease} = 3.3\ W/(m^*K)$ | | | 0.667 | | K/W |

(table continues...)

Table 4 (continued) Characteristic values

| Parameter | Symbol | Note or test condition | Values | | | Unit |
|--|--------------|------------------------|--------|------|------|------|
| | | | Min. | Typ. | Max. | |
| Temperature under switching conditions | $T_{vj\ op}$ | | -40 | | 150 | °C |

3 Diode, Boost

Table 5 Maximum rated values

| Parameter | Symbol | Note or test condition | Values | Unit | |
|---------------------------------|-----------|--|--------------------------------|------|----------------------|
| Repetitive peak reverse voltage | V_{RRM} | $T_{vj} = 25\ ^\circ\text{C}$ | 1200 | V | |
| Implemented forward current | I_{FN} | | 40 | A | |
| Continuous DC forward current | I_F | | 30 | A | |
| Repetitive peak forward current | I_{FRM} | $t_p = 1\ \text{ms}$ | 80 | A | |
| I^2t - value | I^2t | $V_R = 0\ \text{V}, t_p = 10\ \text{ms}$ | $T_{vj} = 125\ ^\circ\text{C}$ | 200 | A^2s |
| | | | $T_{vj} = 150\ ^\circ\text{C}$ | 111 | |

Table 6 Characteristic values

| Parameter | Symbol | Note or test condition | Values | | | Unit |
|---|------------|---|--------------------------------|-------|------|---------------|
| | | | Min. | Typ. | Max. | |
| Forward voltage | V_F | $I_F = 30\ \text{A}, V_{GE} = 0\ \text{V}$ | $T_{vj} = 25\ ^\circ\text{C}$ | 1.29 | 1.63 | V |
| | | | $T_{vj} = 125\ ^\circ\text{C}$ | 1.49 | | |
| | | | $T_{vj} = 150\ ^\circ\text{C}$ | 1.61 | | |
| Peak reverse recovery current | I_{RM} | $I_F = 30\ \text{A}, V_R = 500\ \text{V}, -di_F/dt = 1900\ \text{A}/\mu\text{s} (T_{vj} = 150\ ^\circ\text{C})$ | $T_{vj} = 25\ ^\circ\text{C}$ | 16.4 | | A |
| | | | $T_{vj} = 125\ ^\circ\text{C}$ | 16.4 | | |
| | | | $T_{vj} = 150\ ^\circ\text{C}$ | 16.4 | | |
| Recovered charge | Q_r | $I_F = 30\ \text{A}, V_R = 500\ \text{V}, -di_F/dt = 1900\ \text{A}/\mu\text{s} (T_{vj} = 150\ ^\circ\text{C})$ | $T_{vj} = 25\ ^\circ\text{C}$ | 0.74 | | μC |
| | | | $T_{vj} = 125\ ^\circ\text{C}$ | 0.74 | | |
| | | | $T_{vj} = 150\ ^\circ\text{C}$ | 0.74 | | |
| Reverse recovery energy | E_{rec} | $I_F = 30\ \text{A}, V_R = 500\ \text{V}, -di_F/dt = 1900\ \text{A}/\mu\text{s} (T_{vj} = 150\ ^\circ\text{C})$ | $T_{vj} = 25\ ^\circ\text{C}$ | 0.249 | | mJ |
| | | | $T_{vj} = 125\ ^\circ\text{C}$ | 0.249 | | |
| | | | $T_{vj} = 150\ ^\circ\text{C}$ | 0.249 | | |
| Thermal resistance, junction to heat sink | R_{thJH} | per diode, $\lambda_{grease} = 3.3\ \text{W}/(\text{m}^*\text{K})$ | | 0.979 | | K/W |

(table continues...)

Table 6 (continued) Characteristic values

| Parameter | Symbol | Note or test condition | Values | | | Unit |
|--|-------------|------------------------|--------|------|------|------|
| | | | Min. | Typ. | Max. | |
| Temperature under switching conditions | $T_{vj,op}$ | | -40 | | 150 | °C |

4 Bypass-diode

Table 7 Maximum rated values

| Parameter | Symbol | Note or test condition | Values | Unit | |
|---|-------------|-------------------------|--------------------------|------|------------------|
| Repetitive peak reverse voltage | V_{RRM} | $T_{vj} = 25\text{ °C}$ | 1200 | V | |
| Maximum RMS forward current per chip | I_{FRMSM} | $T_H = 95\text{ °C}$ | 50 | A | |
| Maximum RMS current at rectifier output | I_{RMSM} | $T_H = 95\text{ °C}$ | 50 | A | |
| Surge forward current | I_{FSM} | $t_p = 10\text{ ms}$ | $T_{vj} = 25\text{ °C}$ | 1070 | A |
| | | | $T_{vj} = 110\text{ °C}$ | 957 | |
| I^2t - value | I^2t | $t_p = 10\text{ ms}$ | $T_{vj} = 25\text{ °C}$ | 5770 | A ² s |
| | | | $T_{vj} = 110\text{ °C}$ | 4580 | |

Table 8 Characteristic values

| Parameter | Symbol | Note or test condition | Values | | | Unit |
|---|-------------|--|--------|-------|------|------|
| | | | Min. | Typ. | Max. | |
| Forward voltage | V_F | $I_F = 45\text{ A}$ $T_{vj} = 110\text{ °C}$ | | 0.88 | | V |
| Reverse current | I_r | $T_{vj} = 150\text{ °C}$, $V_R = 1200\text{ V}$ | | 1 | | mA |
| Thermal resistance, junction to heat sink | R_{thJH} | per diode, $\lambda_{grease} = 3.3\text{ W/(m}^2\text{K)}$ | | 0.549 | | K/W |
| Temperature under switching conditions | $T_{vj,op}$ | | -40 | | 110 | °C |

5 Inverse-polarity protection diode A

Table 9 Maximum rated values

| Parameter | Symbol | Note or test condition | Values | Unit |
|--------------------------------------|-------------|-------------------------|--------|------|
| Repetitive peak reverse voltage | V_{RRM} | $T_{vj} = 25\text{ °C}$ | 1200 | V |
| Maximum RMS forward current per chip | I_{FRMSM} | $T_H = 95\text{ °C}$ | 50 | A |

(table continues...)

Table 9 (continued) Maximum rated values

| Parameter | Symbol | Note or test condition | Values | Unit | |
|---|------------|------------------------|--------------------------|------|--------|
| Maximum RMS current at rectifier output | I_{RMSM} | $T_H = 95\text{ °C}$ | 50 | A | |
| Surge forward current | I_{FSM} | $t_p = 10\text{ ms}$ | $T_{vj} = 125\text{ °C}$ | 395 | A |
| | | | $T_{vj} = 150\text{ °C}$ | 378 | |
| I^2t - value | I^2t | $t_p = 10\text{ ms}$ | $T_{vj} = 125\text{ °C}$ | 780 | A^2s |
| | | | $T_{vj} = 150\text{ °C}$ | 714 | |

Table 10 Characteristic values

| Parameter | Symbol | Note or test condition | Values | | | Unit |
|---|--------------|--|--------|-------|------|------|
| | | | Min. | Typ. | Max. | |
| Forward voltage | V_F | $I_F = 30\text{ A}$, $T_{vj} = 150\text{ °C}$ | | 0.88 | | V |
| Reverse current | I_r | $T_{vj} = 150\text{ °C}$, $V_R = 1200\text{ V}$ | | 0.1 | | mA |
| Thermal resistance, junction to heat sink | R_{thJH} | per diode, $\lambda_{grease} = 3.3\text{ W/(m}^2\text{K)}$ | | 0.934 | | K/W |
| Temperature under switching conditions | $T_{vj, op}$ | | -40 | | 150 | °C |

6 NTC-Thermistor

Table 11 Characteristic values

| Parameter | Symbol | Note or test condition | Values | | | Unit |
|------------------------|--------------|--|--------|------|------|------|
| | | | Min. | Typ. | Max. | |
| Rated resistance | R_{25} | $T_{NTC} = 25\text{ °C}$ | | 5 | | kΩ |
| Deviation of R_{100} | $\Delta R/R$ | $T_{NTC} = 100\text{ °C}$, $R_{100} = 493\text{ Ω}$ | -5 | | 5 | % |
| Power dissipation | P_{25} | $T_{NTC} = 25\text{ °C}$ | | | 20 | mW |
| B-value | $B_{25/50}$ | $R_2 = R_{25} \exp[B_{25/50}(1/T_2 - 1/(298,15\text{ K}))]$ | | 3375 | | K |
| B-value | $B_{25/80}$ | $R_2 = R_{25} \exp[B_{25/80}(1/T_2 - 1/(298,15\text{ K}))]$ | | 3411 | | K |
| B-value | $B_{25/100}$ | $R_2 = R_{25} \exp[B_{25/100}(1/T_2 - 1/(298,15\text{ K}))]$ | | 3433 | | K |

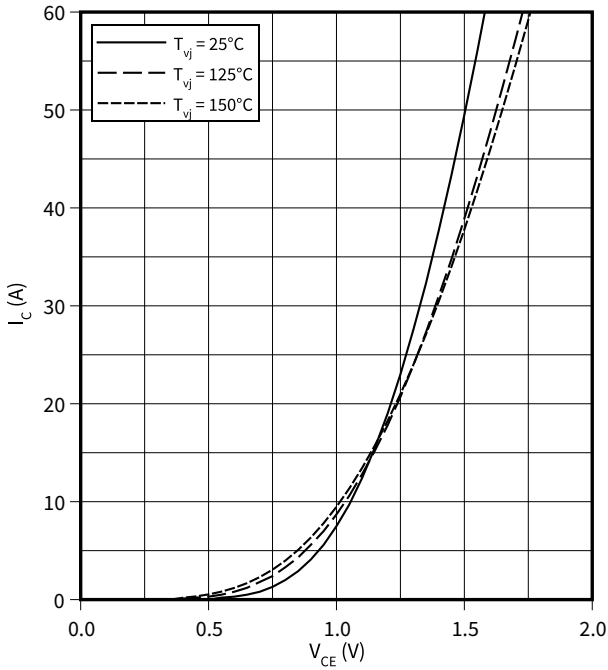
Note: Specification according to the valid application note.

7 Characteristics diagrams

Output characteristic (typical), IGBT, Boost

$$I_C = f(V_{CE})$$

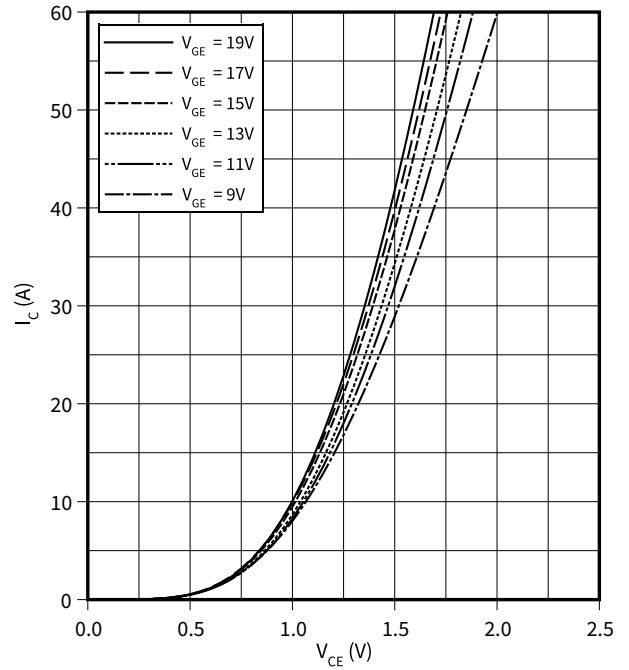
$$V_{GE} = 15 \text{ V}$$



Output characteristic field (typical), IGBT, Boost

$$I_C = f(V_{CE})$$

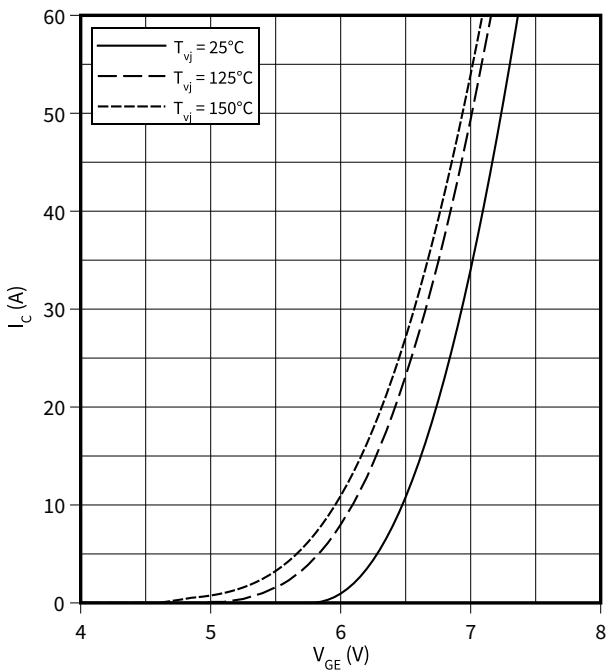
$$T_{vj} = 150 \text{ °C}$$



Transfer characteristic (typical), IGBT, Boost

$$I_C = f(V_{GE})$$

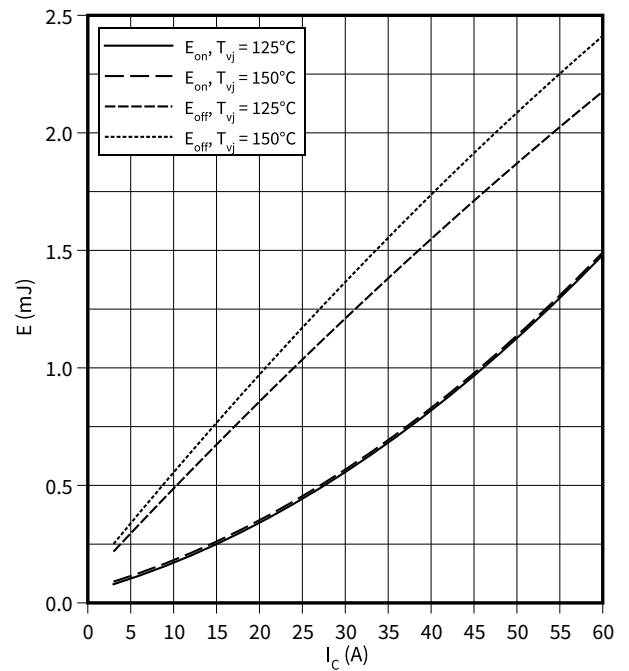
$$V_{CE} = 20 \text{ V}$$



Switching losses (typical), IGBT, Boost

$$E = f(I_C)$$

$$R_{Goff} = 10 \text{ } \Omega, R_{Gon} = 10 \text{ } \Omega, V_{CE} = 500 \text{ V}, V_{GE} = \pm 15 \text{ V}$$

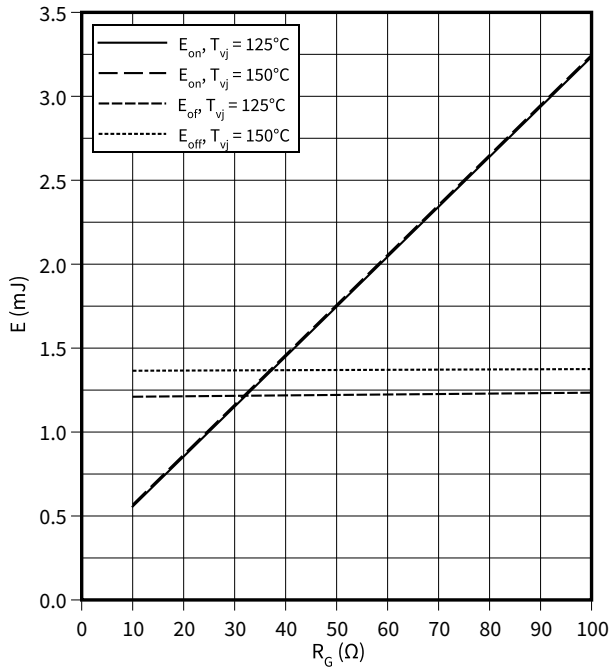


7 Characteristics diagrams

Switching losses (typical), IGBT, Boost

$E = f(R_G)$

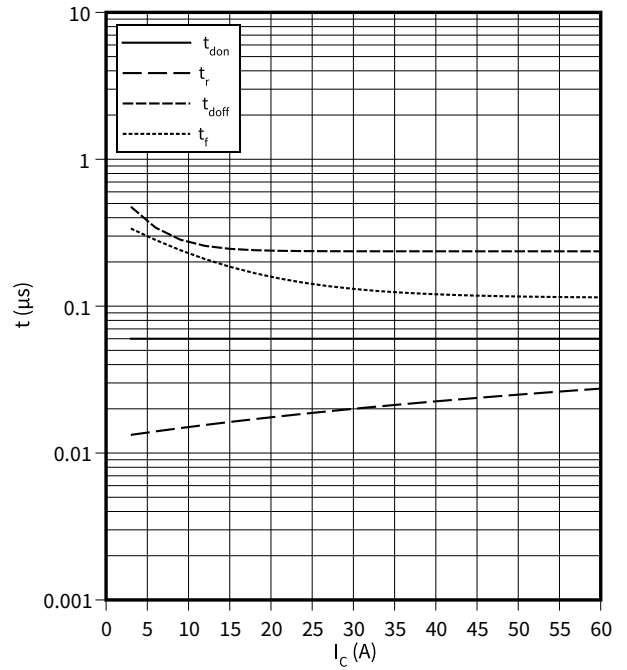
$I_C = 30 \text{ A}, V_{CE} = 500 \text{ V}, V_{GE} = \pm 15 \text{ V}$



Switching times (typical), IGBT, Boost

$t = f(I_C)$

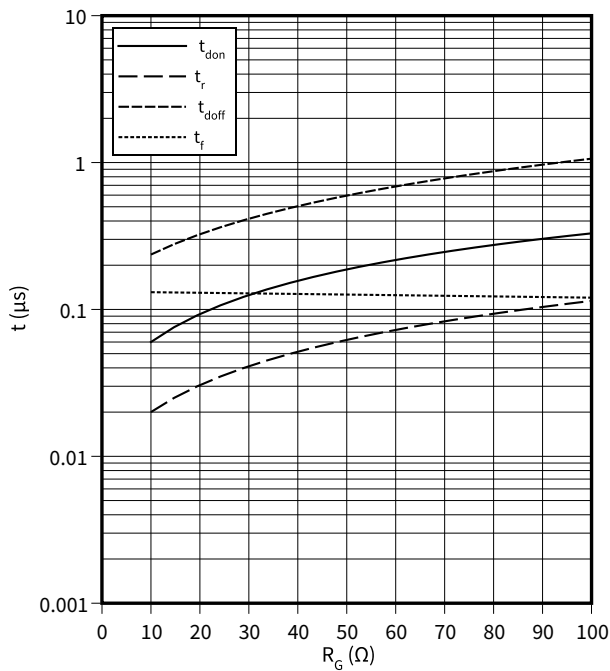
$R_{Goff} = 10 \Omega, R_{Gon} = 10 \Omega, V_{CE} = 500 \text{ V}, V_{GE} = \pm 15 \text{ V}, T_{vj} = 150 \text{ °C}$



Switching times (typical), IGBT, Boost

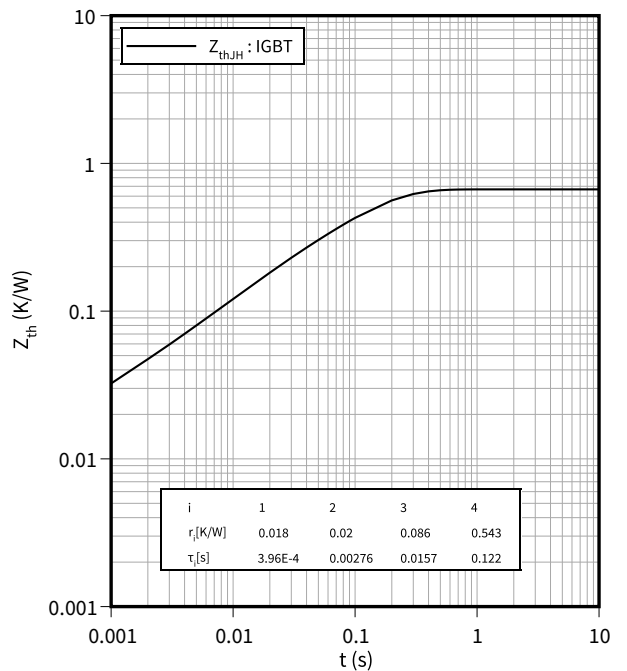
$t = f(R_G)$

$I_C = 30 \text{ A}, V_{CE} = 500 \text{ V}, V_{GE} = \pm 15 \text{ V}, T_{vj} = 150 \text{ °C}$



Transient thermal impedance, IGBT, Boost

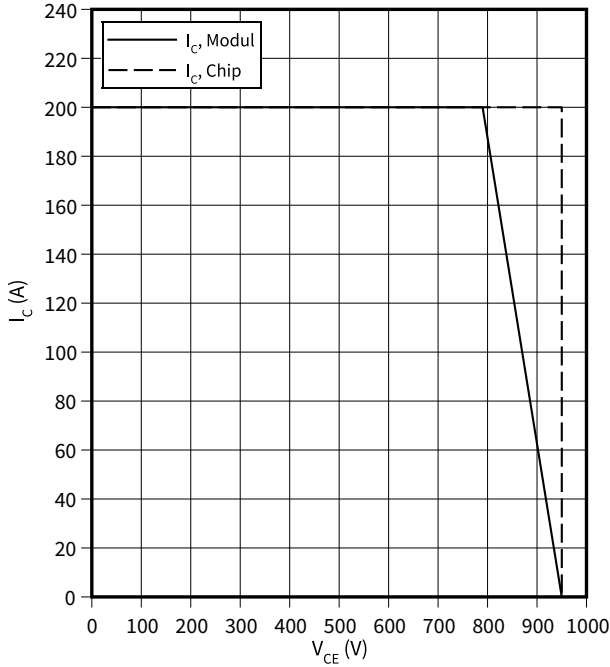
$Z_{th} = f(t)$



Reverse bias safe operating area (RBSOA), IGBT, Boost

$I_C = f(V_{CE})$

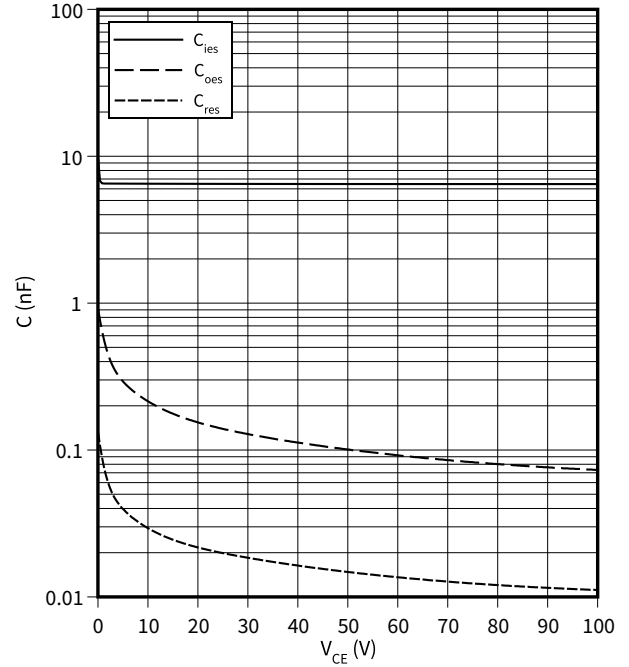
$R_{Goff} = 10 \Omega$, $V_{GE} = \pm 15.0 \text{ V}$, $T_{vj} = 150 \text{ }^\circ\text{C}$



Capacity characteristic (typical), IGBT, Boost

$C = f(V_{CE})$

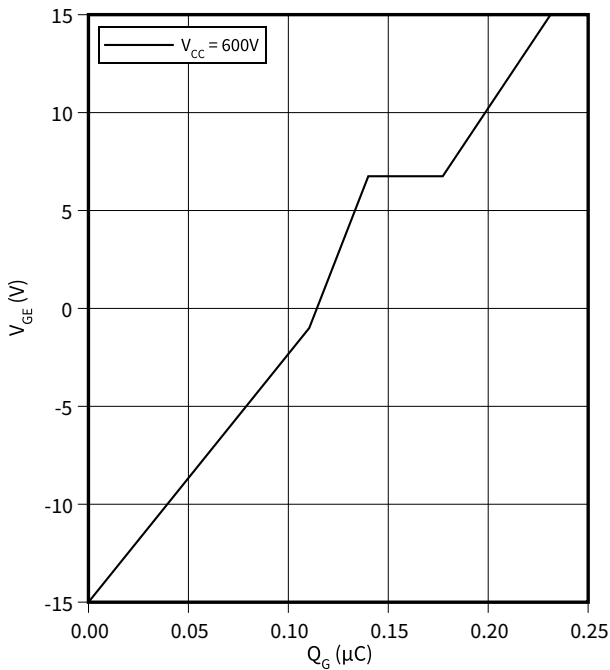
$f = 100 \text{ kHz}$, $V_{GE} = 0 \text{ V}$, $T_{vj} = 25 \text{ }^\circ\text{C}$



Gate charge characteristic (typical), IGBT, Boost

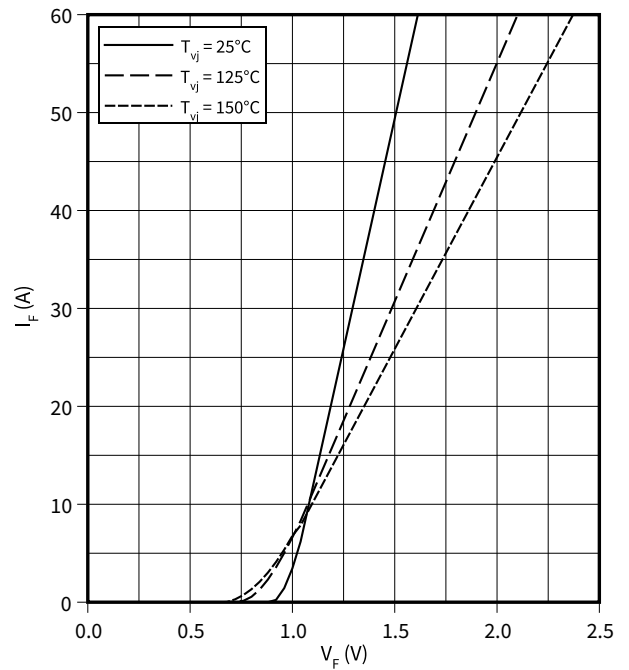
$V_{GE} = f(Q_G)$

$I_C = 100 \text{ A}$, $T_{vj} = 25 \text{ }^\circ\text{C}$



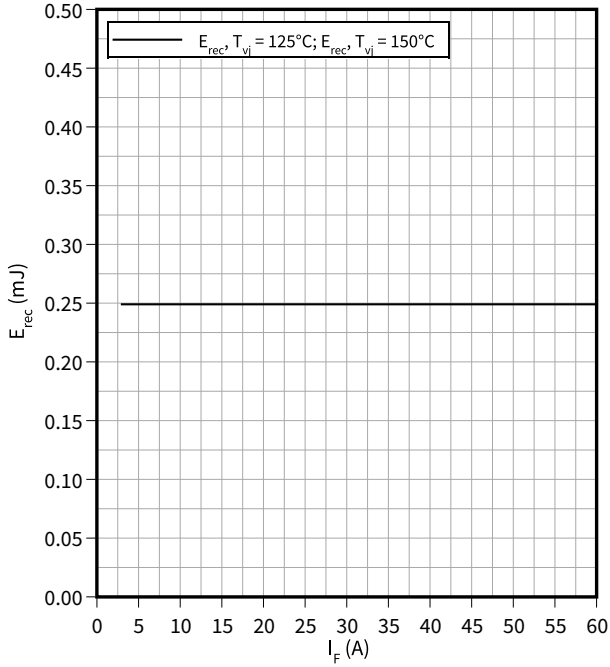
Forward characteristic (typical), Diode, Boost

$I_F = f(V_F)$



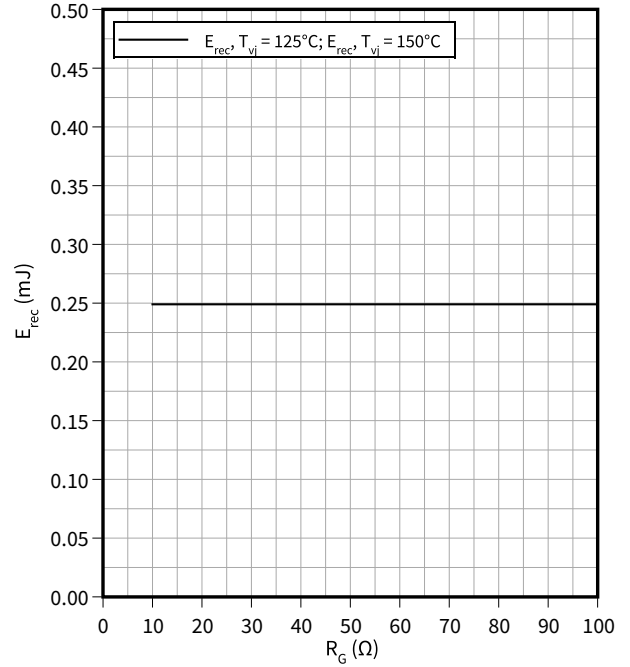
Switching losses (typical), Diode, Boost

$E_{rec} = f(I_F)$
 $R_{Gon} = 10 \Omega, V_{CE} = 500 V$



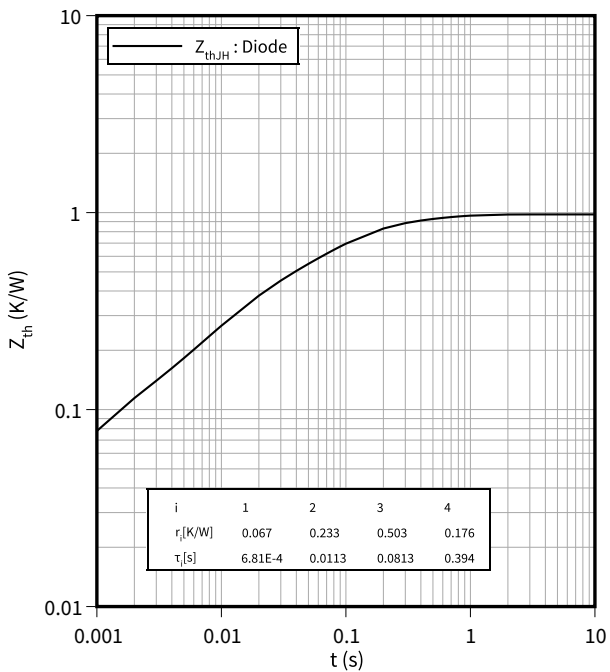
Switching losses (typical), Diode, Boost

$E_{rec} = f(R_G)$
 $V_{CE} = 500 V, I_F = 30 A$



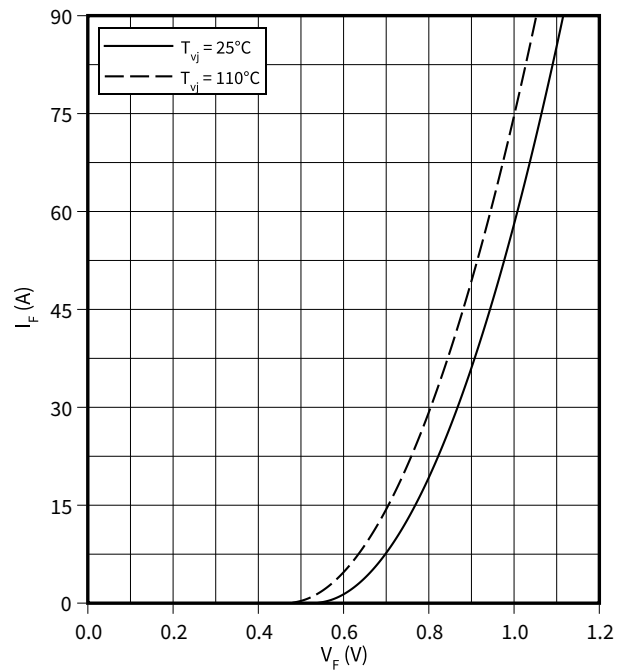
Transient thermal impedance, Diode, Boost

$Z_{th} = f(t)$



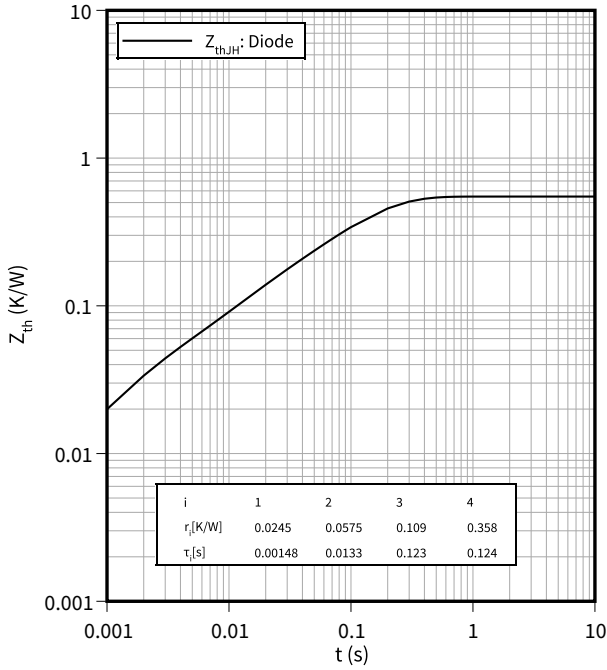
Forward characteristic (typical), Bypass-diode

$I_F = f(V_F)$



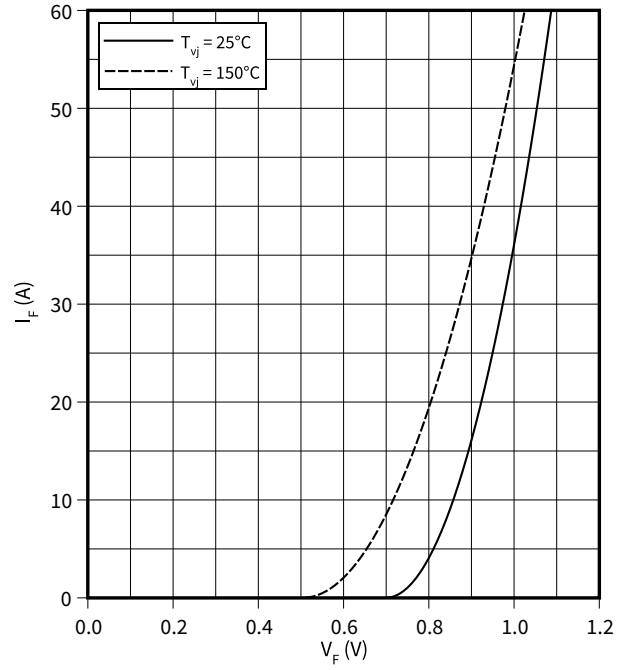
Transient thermal impedance, Bypass-diode

$Z_{th} = f(t)$



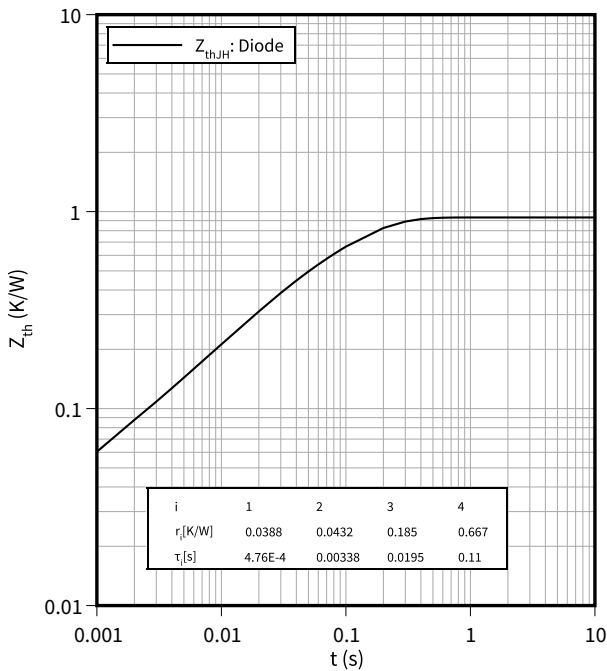
Forward characteristic (typical), Inverse-polarity protection diode A

$I_F = f(V_F)$



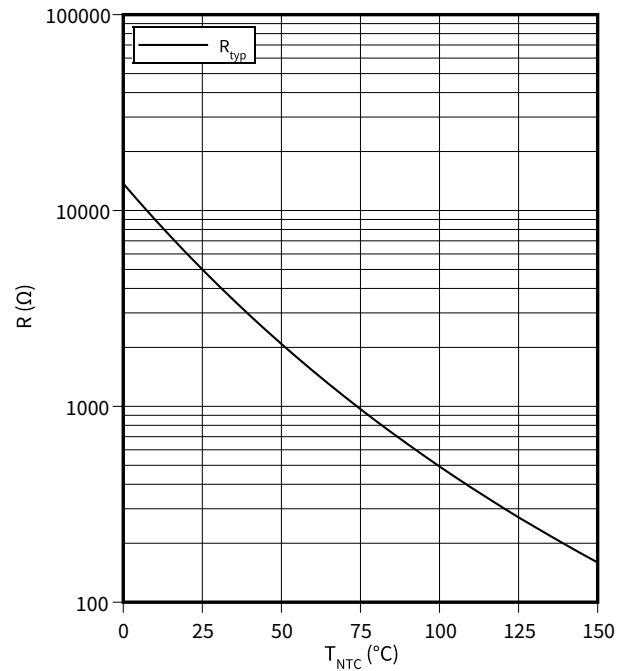
Transient thermal impedance, Inverse-polarity protection diode A

$Z_{th} = f(t)$



Temperature characteristic (typical), NTC-Thermistor

$R = f(T_{NTC})$



8 Circuit diagram

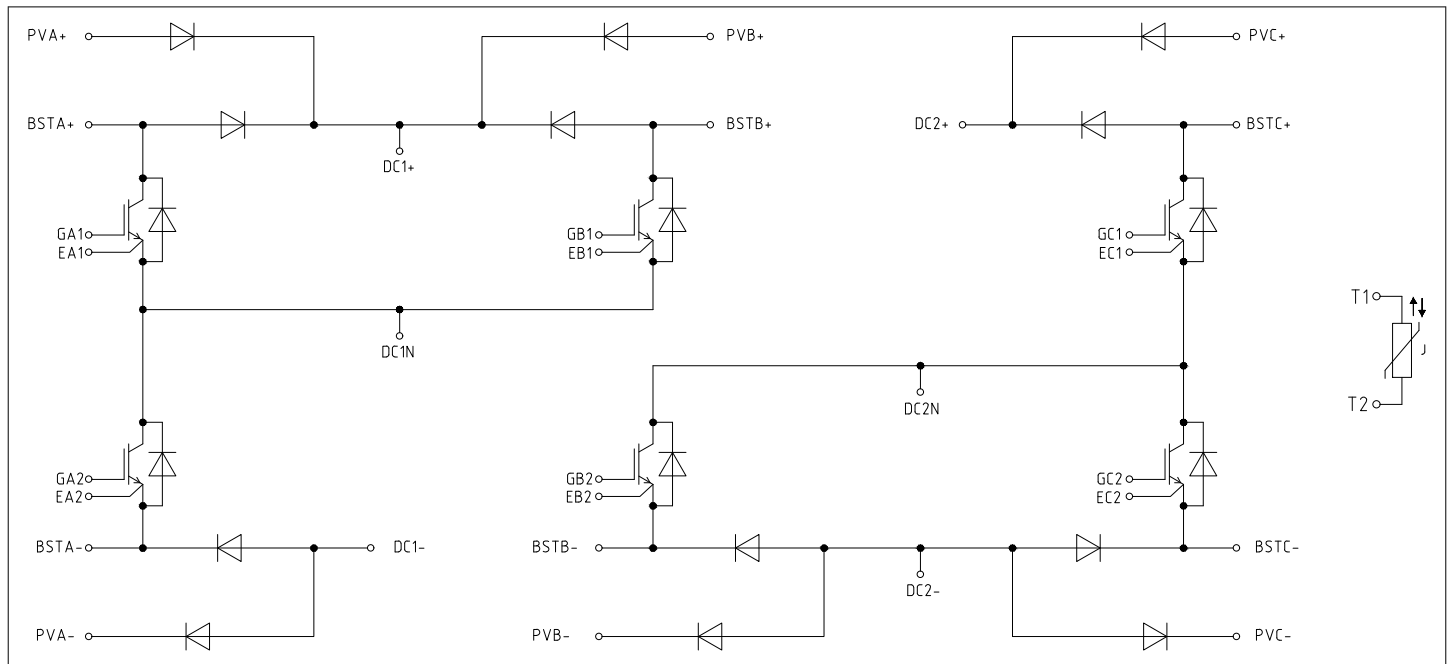


Figure 1

9 Package outlines

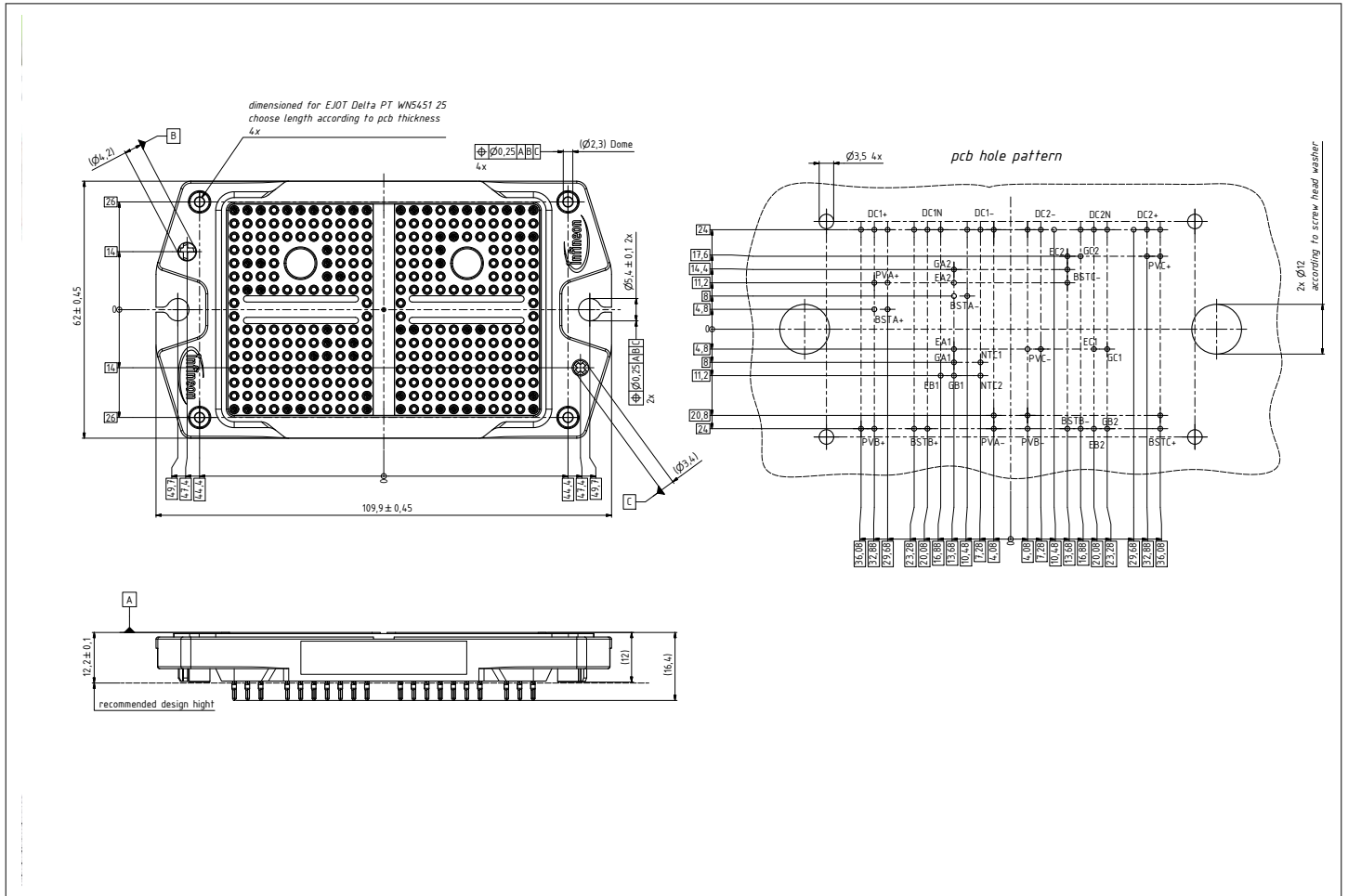


Figure 2

10 Module label code


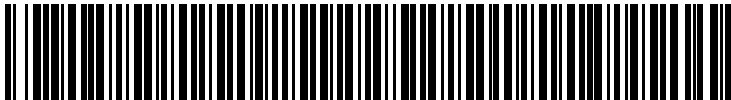
| Module label code | | | |
|-------------------|--|-----------------|-------------------------|
| Code format | Data Matrix | Barcode Code128 | |
| Encoding | ASCII text | Code Set A | |
| Symbol size | 16x16 | 23 digits | |
| Standard | IEC24720 and IEC16022 | IEC8859-1 | |
| Code content | <i>Content</i> | <i>Digit</i> | <i>Example</i> |
| | Module serial number | 1 - 5 | 71549 |
| | Module material number | 6 - 11 | 142846 |
| | Production order number | 12 - 19 | 55054991 |
| | Date code (production year) | 20 - 21 | 15 |
| | Date code (production week) | 22 - 23 | 30 |
| Example |   | | |
| | 71549142846550549911530 | | 71549142846550549911530 |

Figure 3

Revision history

| Document revision | Date of release | Description of changes |
|-------------------|-----------------|------------------------|
| 0.10 | 2020-12-15 | |
| 1.00 | 2022-02-16 | Final datasheet |

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Edition 2022-02-16

Published by

Infineon Technologies AG

81726 Munich, Germany

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Document reference

IFX-AAK566-002

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